281695-3 - ACTIVE

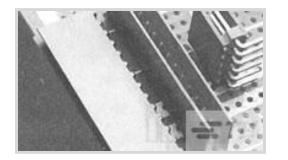
AMPMODU | AMPMODU HE 13/HE 14

TE Internal #: 281695-3 PCB Mount Header, Vertical, Wire-to-Board, 3 Position, .1 in [2.54 mm] Centerline, Partially Shrouded, Tin, Through Hole - Solder, AMPMODU HE 13/HE 14

View on TE.com >



Connectors > PCB Connectors > PCB Headers & Receptacles > HE13/HE14 TH Headers, SRST



Connector System: Wire-to-Board

Number of Positions: 3

Number of Rows: 1

Centerline (Pitch): 2.54 mm [.1 in]

PCB Mount Orientation: Vertical

All HE13/HE14 TH Headers, SRST (21)

Features

Product Type Features

Connector System

Header Type

Wire-to-Board

Partially Shrouded

Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
PCB Connector Assembly Type	PCB Mount Header
Configuration Features	
Connector Contact Load Condition	Fully Loaded
Number of Positions	3
Number of Rows	1
PCB Mount Orientation	Vertical
Electrical Characteristics	
Insulation Resistance	1000 MΩ
Dielectric Withstanding Voltage (Max)	500 V
Body Features	
Primary Product Color	Blue
Contact Features	

C For support call+1 800 522 6752

PCB Mount Header, Vertical, Wire-to-Board, 3 Position, .1 in [2.54 mm] Centerline, Partially Shrouded, Tin, Through Hole - Solder, AMPMODU HE 13/HE 14



Contact Mating Area Length	7 mm
Mating Square Post Dimension	.64 mm[.025 in]
Contact Mating Area Plating Material Thickness	.8 μm[31 μin]
Contact Shape & Form	Square
Contact Mating Area Plating Material Finish	Matte
Contact Underplating Material	Nickel
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Phosphor Bronze
Contact Mating Area Plating Material	Tin
Contact Type	Pin
Contact Current Rating (Max)	3 A
Termination Features	
Square Termination Post & Tail Dimension	.63 mm[.025 in]
Termination Post & Tail Length	2.9 mm
Termination Method to Printed Circuit Board	Through Hole - Solder
Mechanical Attachment	
Mating Alignment Type	Polarization
Mating Retention	With
Panel Mount Feature	Without
Connector Mounting Type	Board Mount
Mating Alignment	With
PCB Mount Retention	Without
Housing Features	
Housing Material	High Temperature Thermoplastic
Centerline (Pitch)	2.54 mm[.1 in]
Usage Conditions	
Operating Temperature Range	-40 - 100 °C[-40 - 212 °F]
Operation/Application	
Circuit Application	Signal
Industry Standards	
Approved Standards	CSA LR7189, UL E28476
UL Flammability Rating	UL 94V-0

PCB Mount Header, Vertical, Wire-to-Board, 3 Position, .1 in [2.54 mm] Centerline, Partially Shrouded, Tin, Through Hole - Solder, AMPMODU HE 13/HE 14



Packaging Features

Packaging Quantity	2000
Packaging Type	Box

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2022 (224) Candidate List Declared Against: JAN 2022 (223) SVHC > Threshold: Not Yet Reviewed
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Wave solder capable to 265°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

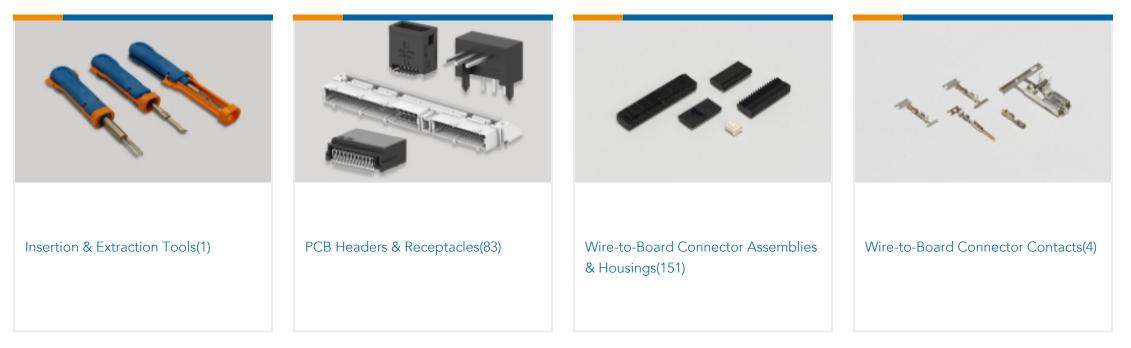
Compatible Parts



PCB Mount Header, Vertical, Wire-to-Board, 3 Position, .1 in [2.54 mm] Centerline, Partially Shrouded, Tin, Through Hole - Solder, AMPMODU HE 13/HE 14



Also in the Series AMPMODU HE 13/HE 14



Customers Also Bought



TE Part #1-215460-4TE Part #1776266-3TE Part #6-1437562-8MICRO-MATCH FEM.SEVert Side Wire Entry, 5.0mm, GTT41NGPC9T1/4=SW TOGGLE 4
POLE

Documents

Product Drawings HEADER HE14 STRAIGHT 3 P

English

CAD Files

Customer View Model

ENG_CVM_CVM_281695-3_G.2d_dxf.zip

English

3D PDF

3D

Customer View Model

ENG_CVM_CVM_281695-3_G.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_281695-3_G.3d_stp.zip

PCB Mount Header, Vertical, Wire-to-Board, 3 Position, .1 in [2.54 mm] Centerline, Partially Shrouded, Tin, Through Hole - Solder, AMPMODU HE 13/HE 14



English

By downloading the CAD file I accept and agree to the $\ensuremath{\mathsf{Terms}}\xspace$ and $\ensuremath{\mathsf{Conditions}}\xspace$ of use.

Product Specifications

Product Specification

French

Product Environmental Compliance MD_281695-3_021520162329_dmtec

English

MD_281695-3_021520162329_dmtec

English